		Sheet 1 of 1		
B/O Form PTO-1449	Atty. Docket Number	Serial Number		
	CHEN3585/EM	Unassigned		
U.S. Department of Commerce	Applicant			
Patent and Trademark Office	Sinn-Wen CHEN			
Information Disclosure Statement by Applicant	Filing Date	Group		
	Concurrently Herewith - Sept. 9, 2003			

## **U.S. Patent Documents**

Examiner Initial	Document Number	Date	Patentee/Applicant	Class	Subclass	Filing Date if Appropriate
				<u> </u>		

**Foreign Patent Documents** 

Examiner Initial	Document Number	Publication Date	Country/Agency	Class	Subclass	Translation	
						Yes	No
			<del></del>				

Other Documents (Including Author, Title, Date, Pertinent Pages, Place of Publication, Etc.)

/J.S./	H. B. Huntington, Electromigration in Metals in Diffusion In Solids: Recent Developments, pp. 303-353, edited by Nowick and Burton, Academic Press, New York, 1975.
/J.S./	M. Y. Hsieh et. al., Electromigration of Copper in Lead, J. Phys. Chem. Solids, Vol. 39, pp. 867-871, 1978
/J.S./	C. K. Hu et. al., <i>Diffusion and electromigration of silver and nickel in lead-tin alloys</i> , Physical Review, Vol. 26, No. 6, pp. 2782-2789, 1982

Examiner	/John Sheehan/	Date Considered	06/06/2007

EXAMINER: Initial if citation is considered, whether or no t citation is in conformance with MPEP 609; Ora walling the ough citation if not in conformance and not considered. Include copy of this form with next communication to applicant.